

FDD6296/FDU6296

30V N-Channel Fast Switching PowerTrench[®] MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

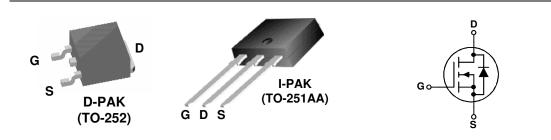
Applications

- DC/DC converter
- Power management

Features

• 50A, 30 V $\begin{array}{l} R_{DS(ON)} = 8.8 \ m\Omega \ @ \ V_{GS} = 10 \ V \\ R_{DS(ON)} = 11.3 \ m\Omega \ @ \ V_{GS} = 4.5 \ V \end{array}$

- Low gate charge
- Fast switching
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$



Absolute Maximum Ratings T_{A=25°C} unless otherwise noted

Symbol	Parameter				F	U	nits		
V _{DSS}	Drain-Source Voltage			30			V		
V _{GSS}	Gate-Source Voltage				± 20				
ID	Continuous	Drain Current	@T _c =25	5°C	(Note 3)		50		А
		@T _A =		°C (Note 1a)		15			7
			Pulsed		(Note 1a)		100		
P _D Power Dissipation		ipation	@T _c =25	5°C	(Note 3)		52		W
			@T _A =25	°C	(Note 1a)		3.8		
			@T _A =25	°C	(Note 1b)		1.6		
T _J , T _{STG}	Operating a	ng and Storage Junction Temperature Range			-5		°C		
Therma	I Charac	teristics							
R _{eJC}	Thermal Resistance, Junction-to-Case (Note 1)				2.9			C/W	
R _{eja}	Thermal Resistance, Junction-to-Ambient (Note 1a)				(Note 1a)	40			
Thermal Resistance, June			tion-to-Ambient (Note 1b)		96				
Packag	e Markin	g and Ore	dering	Infor	matior	ו			
Device I		Device			kage	Reel Size	Tape width	Quan	tity
FDD6296 FDD629		6	D-PAK (TO-252)		13" 16mm		2500 units		
FDU6296 FDU26		FDU269	6	I-PAK (TO-251)		Tube	N/A	75	

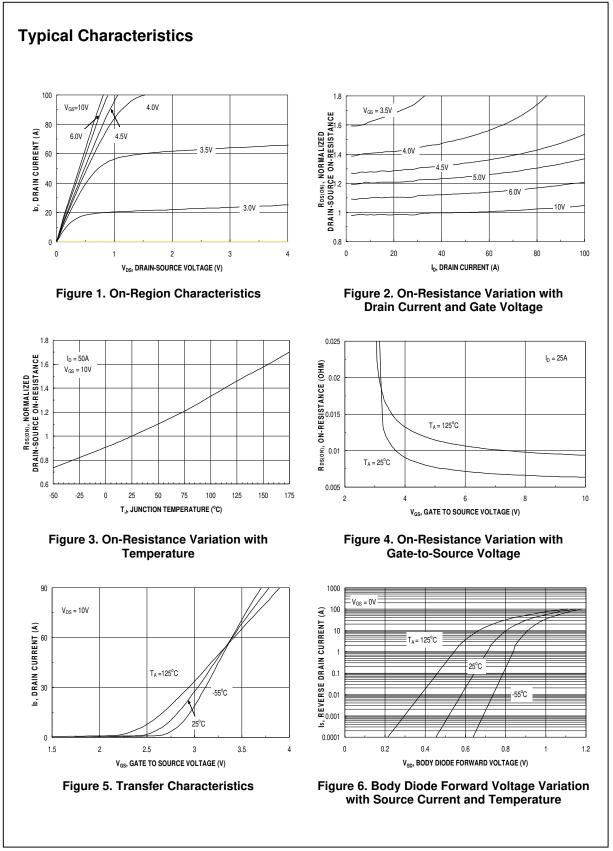
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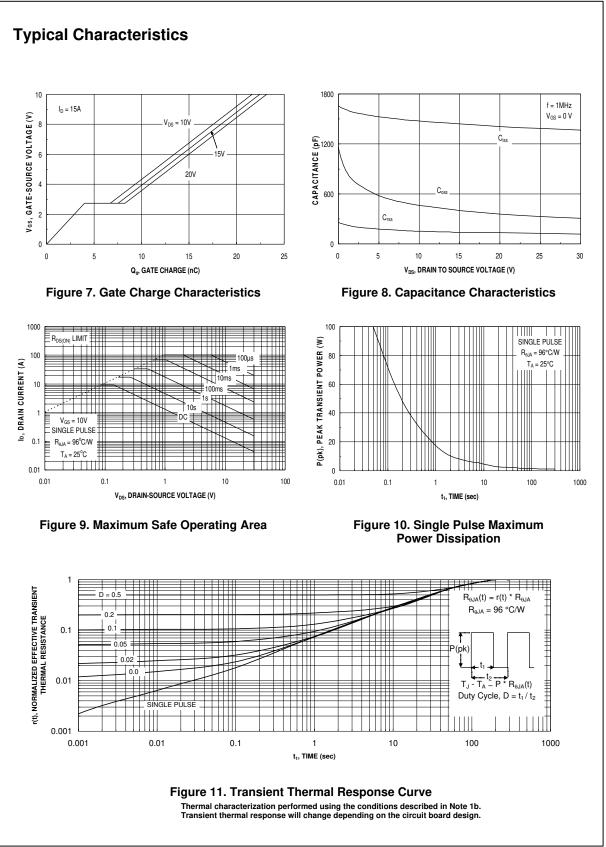
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
- Drain-So	urce Avalanche Ratings (Note	- 2)					
E _{AS}	Drain-Source Avalanche Energy	Single Pulse, $V_{DD} = 15 \text{ V}$, $I_D = 15 \text{ A}$			165	mJ	
I _{AS}	Drain-Source Avalanche Current				15	Α	
Off Chara	acteristics	L		1	1	L	
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS}=0~V, \qquad I_{D}=250~\mu A$	30			V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		29		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 24 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			1	μA	
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			± 100	nA	
On Chara	acteristics (Note 2)						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, \qquad I_{\text{D}} = 250 \ \mu\text{A}$	1	1.7	3	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-0.5		mV/°C	
$R_{\text{DS(on)}}$	Static Drain-Source On-Resistance	$ \begin{array}{ll} V_{GS} = 10 \ V, & I_D = 15 \ A \\ V_{GS} = 4.5 \ V, & I_D = 13 \ A \\ V_{GS} = 10 \ V, & I_D = 15 \ A, \ T_J = 125^\circ C \end{array} $		7.5 9.0 9.3	8.8 11.3 15.0	mΩ	
g fs	Forward Transconductance	$V_{DS} = 5 V$, $I_D = 15 A$		58		S	
	Characteristics						
C _{iss}	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		1440		pF	
Coss	Output Capacitance	f = 1.0 MHz		400		pF	
C _{rss}	Reverse Transfer Capacitance	pacitance		140		pF	
R _G	Gate Resistance	$V_{GS} = 15 \text{ mV}, f = 1.0 \text{ MHz}$		1.3		Ω	
Switching	Characteristics (Note 2)						
t _{d(on)}	Turn-On Delay Time			11	19	ns	
tr	Turn–On Rise Time			6	11	ns	
$t_{d(off)}$	Turn-Off Delay Time			29	46	ns	
t _f	Turn–Off Fall Time			13	23	ns	
Qg	Total Gate Charge	$V_{DS} = 15V, I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}$		22.5	31.5	nC	
Qg	Total Gate Charge	$V_{\text{DS}} = 15 \text{V}, \qquad I_{\text{D}} = 15 \text{ A},$		12.2	17	nC	
Q _{gs}	Gate-Source Charge	$V_{GS} = 5 V$		4		nC	
Q _{gd}	Gate-Drain Charge			3.5		nC	
Drain-So	ource Diode Characteristics	and Maximum Ratings					
ls	Maximum Continuous Drain-Source	ce Diode Forward Current			3.2	Α	
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS}=0~V, I_S=3.2~A \qquad (\text{Note 2})$		0.74	1.2	V	
t _{rr}	Diode Reverse Recovery Time $I_F = 15 A$,			25		nS	
Q _{rr}	Diode Reverse Recovery Charge	$d_{iF}/d_t = 100 \text{ A}/\mu\text{s}$		13		nC	

Electrical Characteristics (cont'd)					
Notes: 1. R _{eJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R _{eJC} is guaranteed by design while R _{eCA} is determined by the user's board design.	FDD6296/FDU6296				
a) $R_{BJA} = 40^{\circ}$ C/W when mounted on a 1in ² pad of 2 oz copper b) $R_{BJA} = 96^{\circ}$ C/W when mounted on a minimum pad.	U6296				
Scale 1 : 1 on letter size paper 2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%					
3. Maximum current is calculated as: current limitation is 21A $\sqrt{\frac{P_D}{R_{DS(ON)}}}$ where P _D is maximum power dissipation at T _C = 25°C and R _{DS(on)} is at T _{J(max)} and V _{GS} = 10V. Package					
FDD6296/FDU6296 Rev. 2.1					



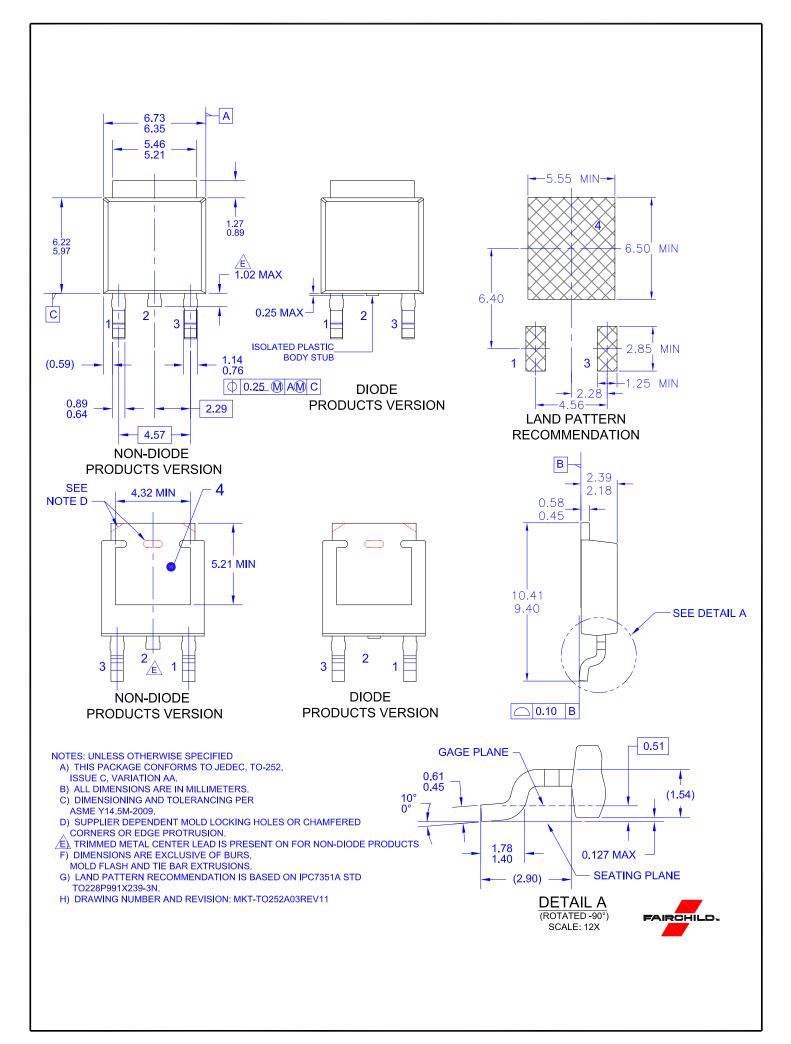
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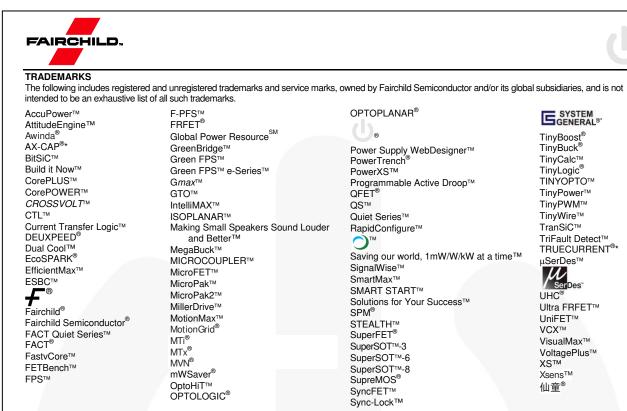
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Rev. 177